

**Product data sheet** 

### 1. General description

N-channel enhancement mode Field-Effect Transistor (FET) in a small SOT23 (TO-236AB) Surface-Mounted Device (SMD) plastic package using Trench MOSFET technology.

### 2. Features and benefits

- Logic-level compatible
- Very fast switching
- Trench MOSFET technology
- 1 kV ESD protected
- AEC-Q101 qualified

### 3. Applications

- Relay driver
- High-speed line driver
- Low-side load switch
- Switching circuits

### 4. Quick reference data

Table 1. Quick r	reference data						
Symbol	Parameter	Conditions		Min	Тур	Max	Unit
V <sub>DS</sub>	drain-source voltage	T <sub>j</sub> = 25 °C		-	-	40	V
V <sub>GS</sub>	gate-source voltage			-20	-	20	V
I <sub>D</sub>	drain current	V <sub>GS</sub> = 10 V; T <sub>amb</sub> = 25 °C	[1]	-	-	2.1	А
Static characteristics							
R <sub>DSon</sub>	drain-source on-state resistance	V <sub>GS</sub> = 10 V; I <sub>D</sub> = 1.5 A; T <sub>j</sub> = 25 °C		-	95	120	mΩ

[1] Device mounted on an FR4 Printed-Circuit Board (PCB), single-sided copper, tin-plated, mounting pad for drain 6 cm<sup>2</sup>.

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# 5. Pinning information

Table 2. Pinning information							
Pin	Symbol	Description	Simplified outline	Graphic symbol			
1	G	gate	3	D			
2	S	source					
3	D	drain	1 2 TO-236AB (SOT23)	G G S 017aaa255			

# 6. Ordering information

Table 3. Ordering information							
Type number	Package	Package					
	Name	Description	Version				
PMV130ENEA	TO-236AB	plastic surface-mounted package; 3 leads	SOT23				

# 7. Marking

#### Table 4. Marking codes

Type number	Marking code[1]
PMV130ENEA	%JX

[1] % = placeholder for manufacturing site code

# 8. Limiting values

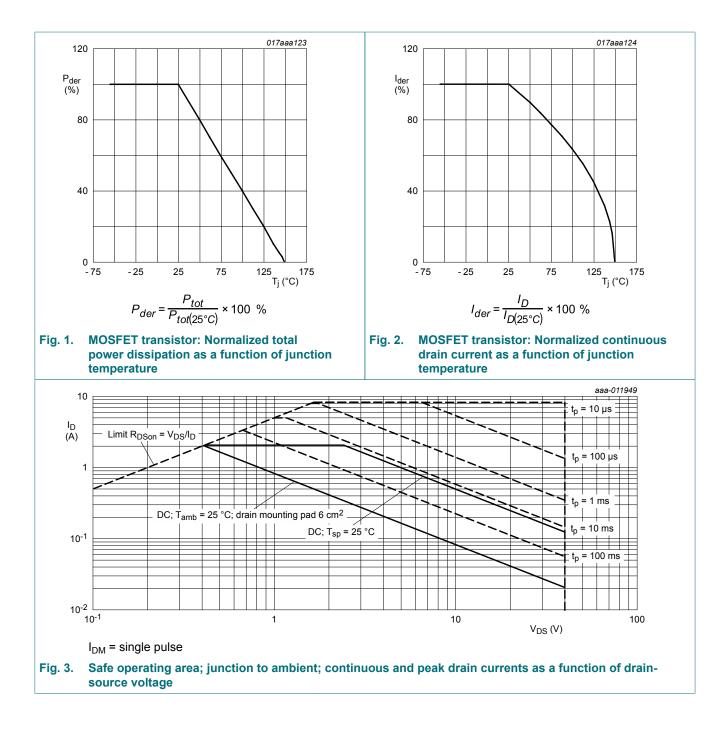
#### Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions		Min	Max	Unit
V <sub>DS</sub>	drain-source voltage	T <sub>j</sub> = 25 °C		-	40	V
V <sub>GS</sub>	gate-source voltage	_		-20	20	V
I <sub>D</sub>	drain current	V <sub>GS</sub> = 10 V; T <sub>amb</sub> = 25 °C	[1]	-	2.1	А
		V <sub>GS</sub> = 10 V; T <sub>amb</sub> = 100 °C	[1]	-	1.3	А
I <sub>DM</sub>	peak drain current	$T_{amb}$ = 25 °C; single pulse; $t_p \le 10 \ \mu s$		-	8	А
P <sub>tot</sub>	total power dissipation	T <sub>amb</sub> = 25 °C	[2]	-	460	mW
			[1]	-	833	mW
		T <sub>sp</sub> = 25 °C		-	5000	mW
Tj	junction temperature			-55	150	°C
T <sub>amb</sub>	ambient temperature			-55	150	°C
T <sub>stg</sub>	storage temperature			-65	150	°C
Source-drain d	liode					
I <sub>S</sub>	source current	T <sub>amb</sub> = 25 °C	[1]	-	0.8	А
ESD maximum	rating					
V <sub>ESD</sub>	electrostatic discharge voltage	НВМ	[3]	-	1000	V
Avalanche rug	gedness		·			
E <sub>DS(AL)S</sub>	non-repetitive drain- source avalanche energy	$T_{j(init)}$ = 25 °C; I <sub>D</sub> = 0.26 A; DUT in avalanche (unclamped)		-	5.8	mJ

 Device mounted on an FR4 Printed-Circuit Board (PCB), single-sided copper, tin-plated, mounting pad for drain 6 cm<sup>2</sup>.
 Device mounted on an FR4 Printed Circuit Board (PCB), single-sided copper, tin-plated and standard footprint. [2]

Measured between all pins. [3]



### 9. Thermal characteristics

Symbol	Parameter	Conditions		Min	Тур	Max	Unit
R <sub>th(j-a)</sub>	thermal resistance	in free air	[1]	-	235	270	K/W
	from junction to ambient		[2]	-	125	150	K/W
R <sub>th(j-sp)</sub>	thermal resistance from junction to solder point			-	20	25	K/W

### Table 6 Thormal characteristics

[1] Device mounted on an FR4 Printed-Circuit Board (PCB), single-sided copper, tin-plated and standard footprint.

[2] Device mounted on an FR4 Printed-Circuit Board (PCB), single-sided copper, tin-plated, mounting pad for drain 6 cm<sup>2</sup>.

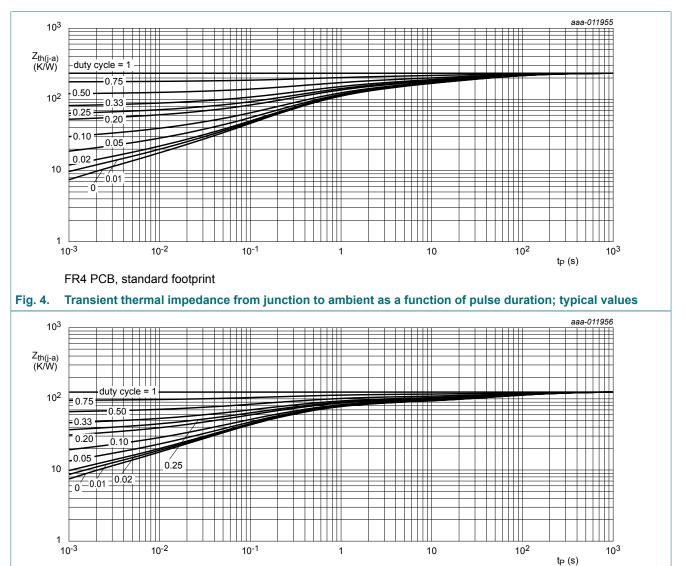


Fig. 5. Transient thermal impedance from junction to ambient as a function of pulse duration; typical values

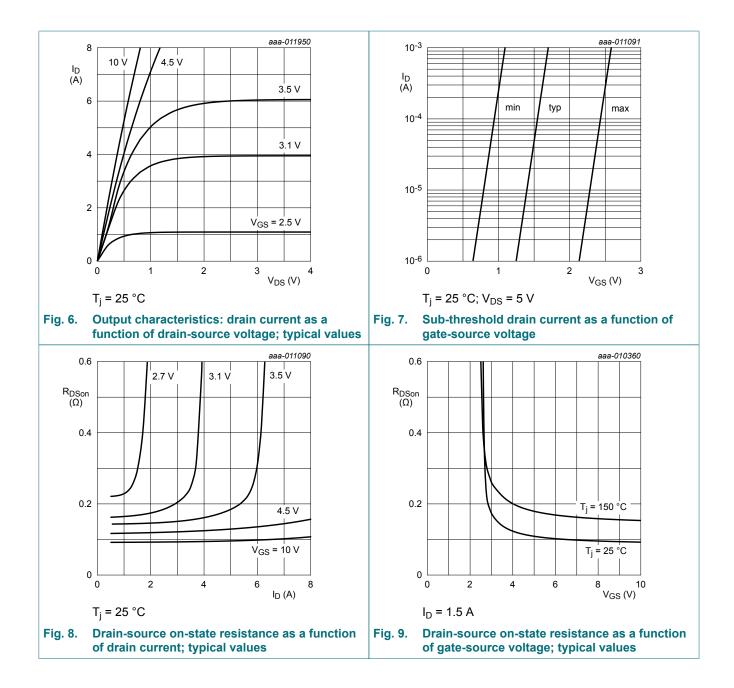
FR4 PCB, mounting pad for drain 6 cm<sup>2</sup>

### **10. Characteristics**

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Static chara	cteristics					
V <sub>(BR)DSS</sub>	drain-source breakdown voltage	$I_D$ = 250 µA; $V_{GS}$ = 0 V; $T_j$ = 25 °C	40	-	-	V
V <sub>GSth</sub>	gate-source threshold voltage	I <sub>D</sub> = 250 μA; V <sub>DS</sub> =V <sub>GS</sub> ; T <sub>j</sub> = 25 °C	1	1.6	2.5	V
I <sub>DSS</sub>	drain leakage current	$V_{DS}$ = 40 V; $V_{GS}$ = 0 V; $T_j$ = 25 °C	-	-	1	μA
		V <sub>DS</sub> = 40 V; V <sub>GS</sub> = 0 V; T <sub>j</sub> = 150 °C	-	-	20	μA
I <sub>GSS</sub>	gate leakage current	$V_{GS}$ = 20 V; $V_{DS}$ = 0 V; $T_j$ = 25 °C	-	-	10	μA
		V <sub>GS</sub> = -20 V; V <sub>DS</sub> = 0 V; T <sub>j</sub> = 25 °C	-	-	-10	μA
R <sub>DSon</sub> drain-source on- resistance	drain-source on-state	V <sub>GS</sub> = 10 V; I <sub>D</sub> = 1.5 A; T <sub>j</sub> = 25 °C	-	95	120	mΩ
	resistance	V <sub>GS</sub> = 10 V; I <sub>D</sub> = 1.5 A; T <sub>j</sub> = 150 °C	-	160	200	mΩ
		V <sub>GS</sub> = 4.5 V; I <sub>D</sub> = 1 A; T <sub>j</sub> = 25 °C	-	120	160	mΩ
9 <sub>fs</sub>	forward transconductance	V <sub>DS</sub> = 10 V; I <sub>D</sub> = 2 A; T <sub>j</sub> = 25 °C	-	4.5	-	S
R <sub>G</sub>	gate resistance	f = 1 MHz; T <sub>j</sub> = 25 °C	-	28	-	Ω
Dynamic ch	aracteristics					
Q <sub>G(tot)</sub>	total gate charge	$V_{DS}$ = 20 V; $I_{D}$ = 1.5 A; $V_{GS}$ = 10 V;	-	2.4	3.6	nC
Q <sub>GS</sub>	gate-source charge	T <sub>j</sub> = 25 °C	-	0.3	-	nC
Q <sub>GD</sub>	gate-drain charge		-	0.4	-	nC
C <sub>iss</sub>	input capacitance	$V_{DS}$ = 20 V; f = 1 MHz; $V_{GS}$ = 0 V;	-	113	170	pF
C <sub>oss</sub>	output capacitance	T <sub>j</sub> = 25 °C	-	27	-	pF
C <sub>rss</sub>	reverse transfer capacitance		-	14	-	pF
t <sub>d(on)</sub>	turn-on delay time	$V_{DS}$ = 20 V; $I_{D}$ = 1.5 A; $V_{GS}$ = 10 V;	-	6	9	ns
t <sub>r</sub>	rise time	R <sub>G(ext)</sub> = 13 Ω; T <sub>j</sub> = 25 °C	-	8	-	ns
t <sub>d(off)</sub>	turn-off delay time		-	11	17	ns
t <sub>f</sub>	fall time		-	3	-	ns
Source-drai	n diode					
V <sub>SD</sub>	source-drain voltage	I <sub>S</sub> = 0.8 A; V <sub>GS</sub> = 0 V; T <sub>i</sub> = 25 °C	-	0.8	1.2	V

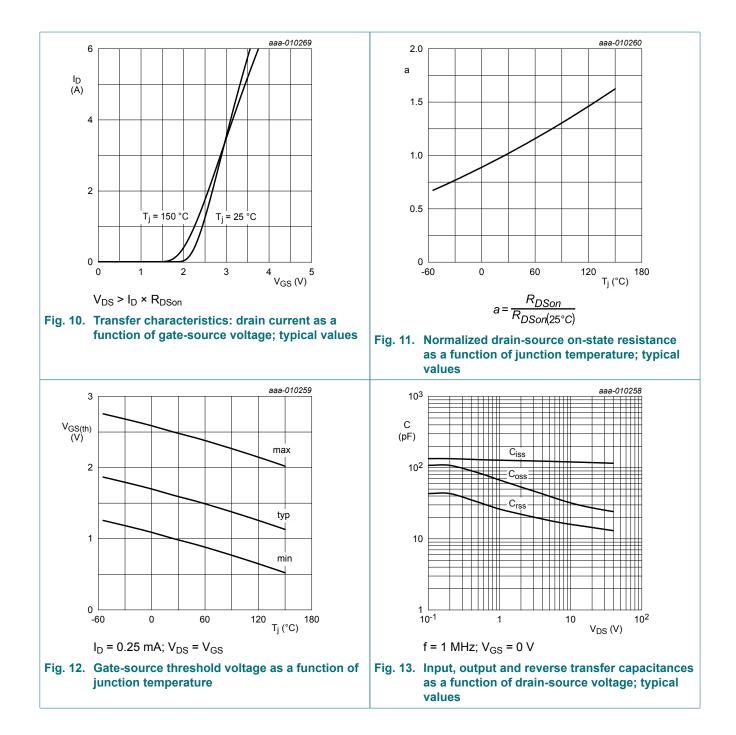
### Nexperia

# **PMV130ENEA**



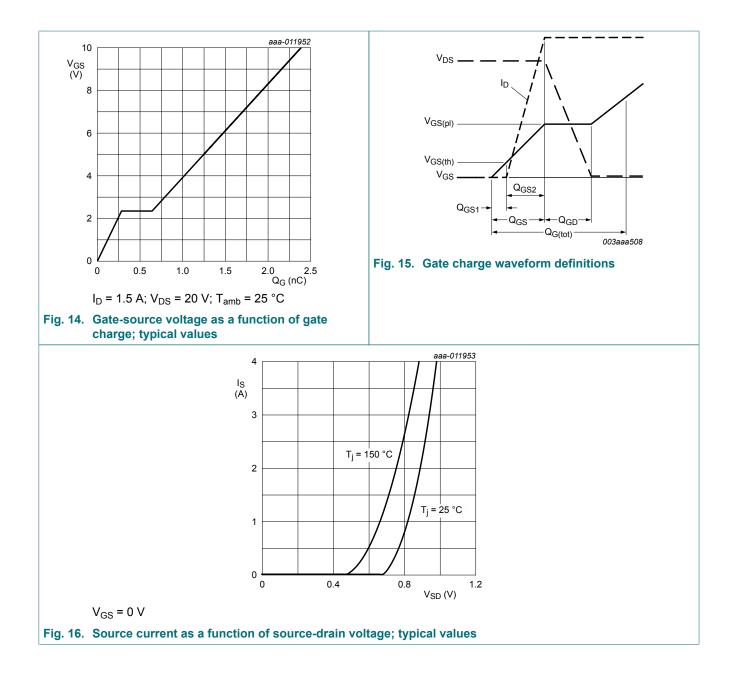
### Nexperia

# **PMV130ENEA**

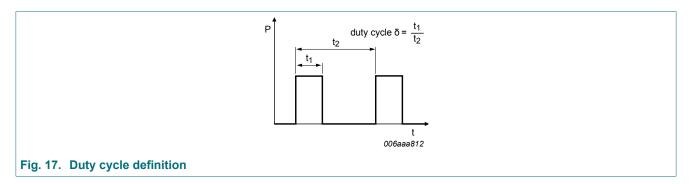


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### **11. Test information**



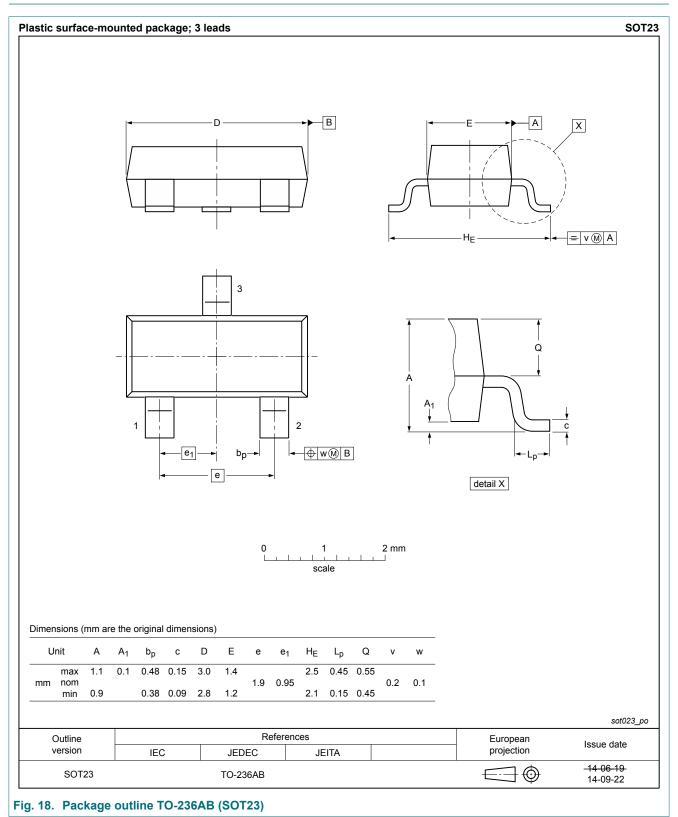
### **Quality information**

This product has been qualified in accordance with the Automotive Electronics Council (AEC) standard Q101 - Stress test qualification for discrete semiconductors, and is suitable for use in automotive applications.

PMV130ENEA

#### 40 V, N-channel Trench MOSFET

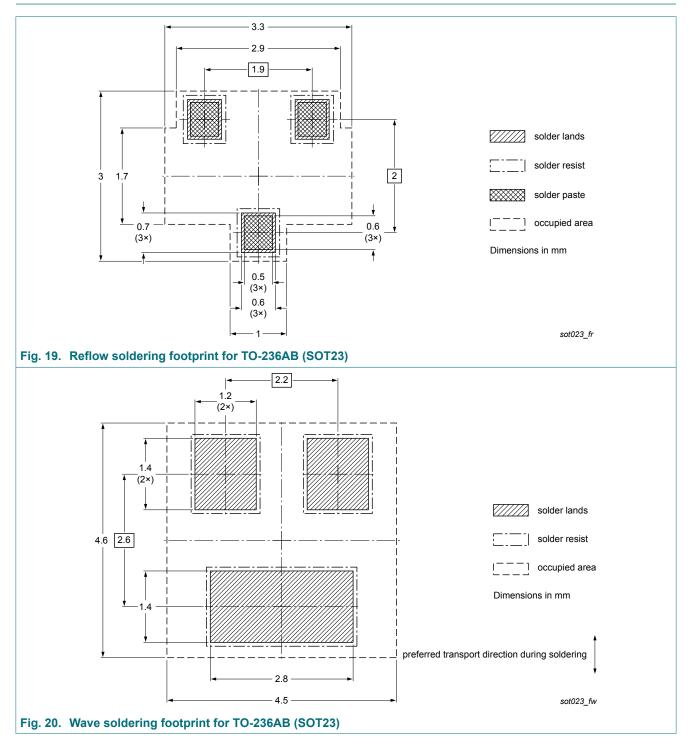
### 12. Package outline



PMV130ENEA

#### 40 V, N-channel Trench MOSFET

### 13. Soldering



# 14. Revision history

Data sheet ID	Release date	Data sheet status	Change notice	Supersedes
PMV130ENEA v.3	20180705	Product data sheet	-	PMV130ENEA v.2
Modifications:	Gate resistance	e changed to $R_G 28 \Omega$		
PMV130ENEA v.2	20140612	Product data sheet	-	PMV130ENEA v.1
PMV130ENEA v.1	20140313	Preliminary data sheet	-	-

#### 40 V, N-channel Trench MOSFET

### 15. Legal information

#### Data sheet status

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

[1] Please consult the most recently issued document before initiating or completing a design.

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#### 40 V, N-channel Trench MOSFET

### Contents

2. Features and benefits	1.	General description	1
4. Quick reference data       1         5. Pinning information       2         6. Ordering information       2         7. Marking       2         8. Limiting values       3         9. Thermal characteristics       5         10. Characteristics       6         11. Test information       10         12. Package outline       11         13. Soldering       12         14. Revision history       13	2.	Features and benefits	. 1
5. Pinning information       2         6. Ordering information       2         7. Marking       2         8. Limiting values       3         9. Thermal characteristics       5         10. Characteristics       6         11. Test information       10         12. Package outline       11         13. Soldering       12         14. Revision history       13	3.	Applications	. 1
6. Ordering information       2         7. Marking       2         8. Limiting values       3         9. Thermal characteristics       5         10. Characteristics       6         11. Test information       10         12. Package outline       11         13. Soldering       12         14. Revision history       13	4.	Quick reference data	1
7. Marking	5.	Pinning information	2
8. Limiting values	6.	Ordering information	2
9. Thermal characteristics510. Characteristics611. Test information1012. Package outline1113. Soldering1214. Revision history13	7.	Marking	2
10. Characteristics	8.	Limiting values	. 3
<ol> <li>Test information</li></ol>	9.	Thermal characteristics	. 5
<ul><li>12. Package outline</li></ul>	10.	Characteristics	6
<ul><li>13. Soldering12</li><li>14. Revision history13</li></ul>	11.	Test information	10
14. Revision history13	12.	Package outline	11
-	13.	Soldering	12
15. Legal information14	14.	Revision history	13
	15.	Legal information	14

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PMV130ENEA